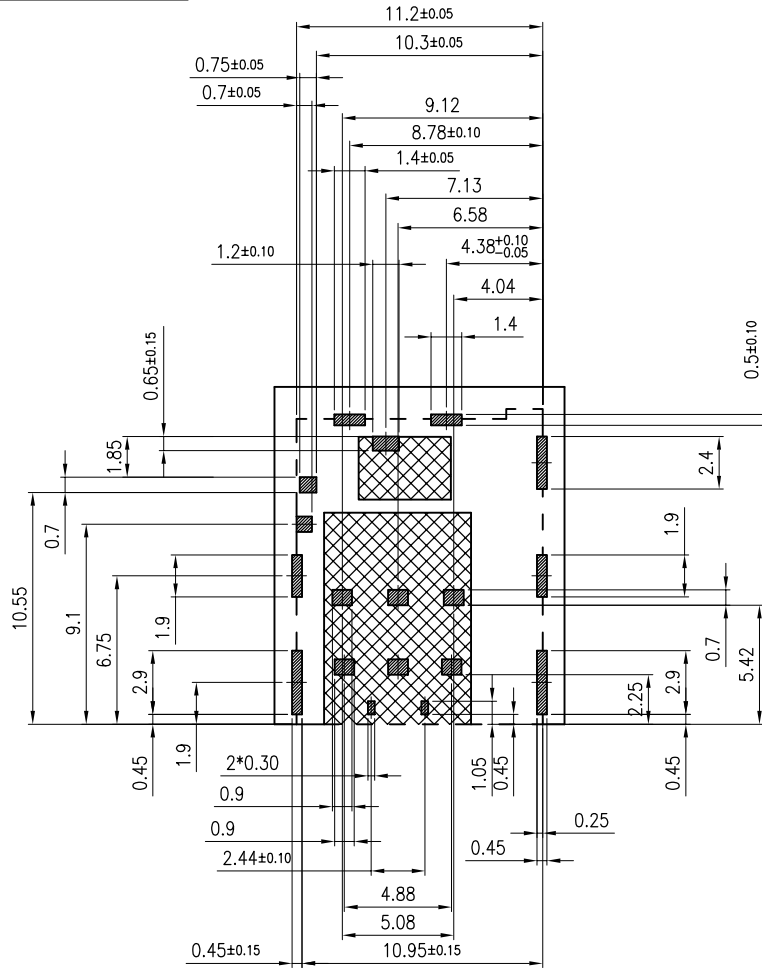


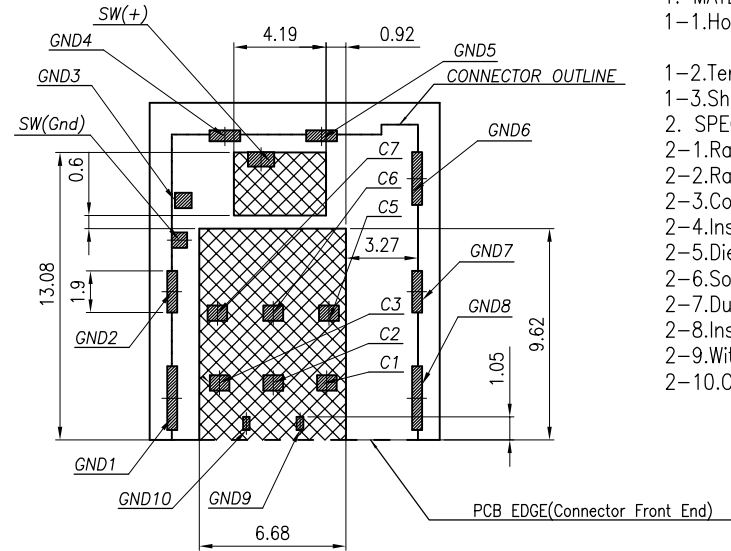
RoHS Compliant

REVISIONS

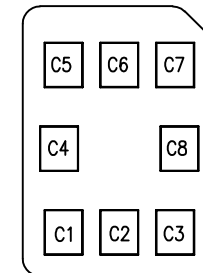
REV.	DESCRIPTION	DATE	DESIGN



RECOMMENDED PCB LAYOUT TOP VIEW (TOLERANCE:±0.05)
RECOMMENDED MATAL MASK T=0.12MM



NO PATTERN AND VIA HOLE IN HTIS AREA
SMT SOLDER AREA



PIN	Name
C1	Vcc
C2	RST
C3	CLK
C4	Reserved
C5	GND
C6	Vpp
C7	I/O
C8	Reserved

SIM Card Pin Assignments

NOTES:

- MATERIAL:
1-1.Housing:High Temperature Thermoplastic UL94V-0; Color Black.
1-2.Terminal:Copper Alloy.
1-3.Shell:Stainless Steel.
- SPECIALITY:
2-1.Rated current:0.5A
2-2.Rated voltage:30V
2-3.Contact Resistance:100mΩ MAX
2-4.Insulation Resistance:100MΩ MIN 500V DC
2-5.Dielectric withstanding voltage: 100V AC.
2-6.Solder ability:255±5℃, 10±0.5s.
2-7.Durability:5000 Cycles Min.
2-8.Insertion Force:10N MAX
2-9.Withdrawal Force:0.5N MIN
2-10.Operating condition:Temperature-40℃~+85℃;
Humidity 80% R.H MAX

Bestcreate Technology Limited

REV: A UNIT mm SCALE 1=1 QUALITY SYMBOLS

TOLERANCES UNLESS OTHERWISE SPECIFIED:

.X	±	0.30	X.*	±	5*
.XX	±	0.20	.X.*	±	2*
.XXX	±	0.10	.XX.*	±	1*

Website:www.bsc-elec.com
Email:bestcreate@bsc-elec.com

DESIGN: DATE:

I. L 2017. 3. 1

CHECKED: DATE:

C. W 2017. 3. 1

APPROVED: DATE:

C. W 2017. 3. 1

TITLE:

1. 25 NANO SIM PUSH CONN

MATERILA: PART NO: NSIM-07XX5R-017 SIZE: A4

FINSH: DWG NO: NSIM-07XX5R-017 2 OF 3

RoHS Compliant

← 组装包装方向

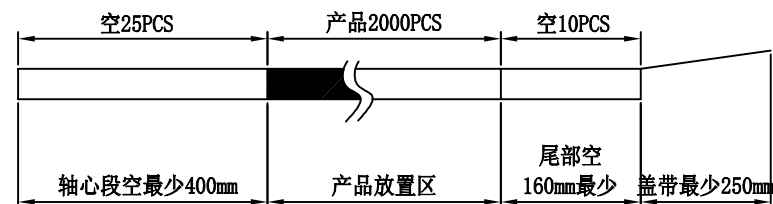
客户出料方向 →

REVISIONS

REV.	DESCRIPTION	DATE	DESIGN

NOTES

- 每卷包装数量:2000PCS/每卷
- 卷带包装方式:



- 每箱包装数量:20000PCS/箱

盖带剥离角度:165°~180°
剥离力:20~130g

载带

放大图 B

放大图 B

护角

10-卷

胶带工字型封箱

底部与顶部各放
一块珍珠棉保护

RoHS
标签

纸箱
350*350*340 K=K

Bestcreate Technology Limited

TOLERANCES UNLESS OTHERWISE SPECIFIED:

.X	±	0.30	X.*	±	5*
.XX	±	0.20	.X*	±	2*
.XXX	±	0.10	.XX*	±	1*

Website:www.bsc-elec.com
Email:bestcreate@bsc-elec.com

DESIGN:

I.L

CHECKED:

C.W

APPROVED:

C.W

DATE:

2017.3.1

DATE:

2017.3.1

DATE:

2017.3.1

TITLE:

1.25 NANO SIM PUSH CONN

MATERIAL:

PART NO:

NSIM-07XX5R-017

SIZE:

A4

FINISH:

DWG NO:

NSIM-07XX5R-017

3 OF 3

REV:
A

UNIT
mm

SCALE
1=1

QUALITY
SYMBOLS

